

# **ST-SOT23-3**

**SOT23-3 SMD to DIP Adapter** 





- Converts a SOT-23 SMD part to a DIP form factor
- High quality PCB can withstand re-work
- Enables SMD parts to be used with a breadboard or perfboard
- 0.1" pitch holes for standard headers

Specifications	
DIP Pitch	0.1"
SMD Package	SOT23-3
Surface Finish	LF HASL
Temperature Rating	-30°C to +100°C

This SMD to DIP breakout board enables the easy conversion of a surface mount package to a DIP form factor. This adapter makes prototyping with surface mount parts fast and easy. Holes with a standard 0.1" pitch allow the board to work with common headers and enable SMD parts to be used in bread-boards and perfboards. This board has an LF HASL surface finish and is made of high quality FR4 which can withstand high temperature soldering and re-work.

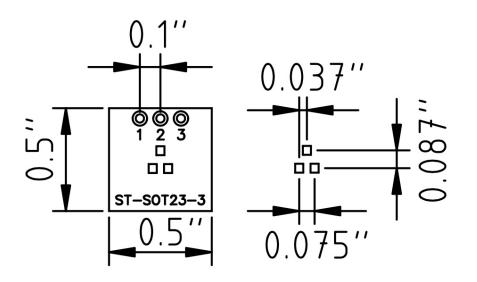
SchmalzTech, LLC www.schmalztech.com



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## **Mechanical Drawings**

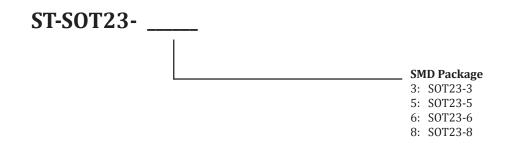


### **Electrical Connections**

Each pin of the SOT-23 SMD part is electrically connected to one of the through hole connections on the SMD to DIP adapter board.



# **ST-SOT23 - Ordering Information**



### Ordering

To order please visit www.schmalztech.com or one of our distributors to quickly place an online order.

Orders may also be placed by email or phone: Email: sales@schmalztech.com Phone: +1 (844) 399-9213

### **Expedited Shipping**

If overnight shipping is required please contact us directly so that we can expedite your order. Overnight shipping is provided through UPS and will incur an additional charge

#### **Custom Designs**

Can't find what you need? We can design and produce a custom board to fit your exact needs. Please reach out to us for additional information and pricing.